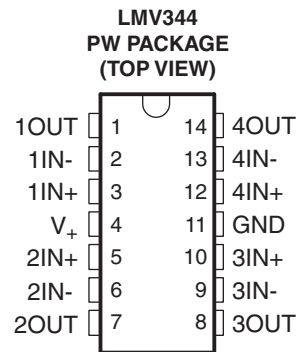
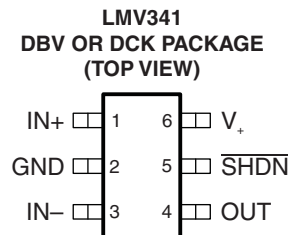


RAIL-TO-RAIL OUTPUT CMOS OPERATIONAL AMPLIFIERS

FEATURES

- Qualified for Automotive Applications
- 2.7-V and 5-V Performance
- Rail-to-Rail Output Swing
- Input Bias Current: 1 pA Typ
- Input Offset Voltage: 0.25 mV Typ
- Low Supply Current: 100 μ A Typ
- Gain Bandwidth: 1 MHz Typ
- Slew Rate: 1 V/ μ s Typ
- Turn-On Time From Shutdown: 5 μ s Typ
- Input Referred Voltage Noise (at 10 kHz): 20 nV/ $\sqrt{\text{Hz}}$



DESCRIPTION/ORDERING INFORMATION

The LMV341 and LMV344 devices are single and quad CMOS operational amplifiers, respectively, with low voltage, low power, and rail-to-rail output swing capabilities. The PMOS input stage offers an ultra-low input bias current of 1 pA (typ) and an offset voltage of 0.25 mV (typ). The single supply amplifier is designed specifically for low-voltage (2.7 V to 5 V) operation, with a wide common-mode input voltage range that typically extends from -0.2 V to 0.8 V from the positive supply rail. Additional features are a 20-nV/ $\sqrt{\text{Hz}}$ voltage noise at 10 kHz, 1-MHz unity-gain bandwidth, 1-V/ μ s slew rate, and 100- μ A current consumption per channel.

An extended industrial temperature range from -40°C to 125°C makes this device suitable for automotive applications.

ORDERING INFORMATION⁽¹⁾

T_A	PACKAGE ⁽²⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING ⁽³⁾
-40°C to 125°C	SC-70 – DCK	Reel of 3000	LMV341QDCKRQ1	RR_
	SOT-23 – DBV	Reel of 3000	LMV341QDBVRQ1	RCH_
	TSSOP – PW	Reel of 2000	LMV344IPWRQ1	LMV344Q

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

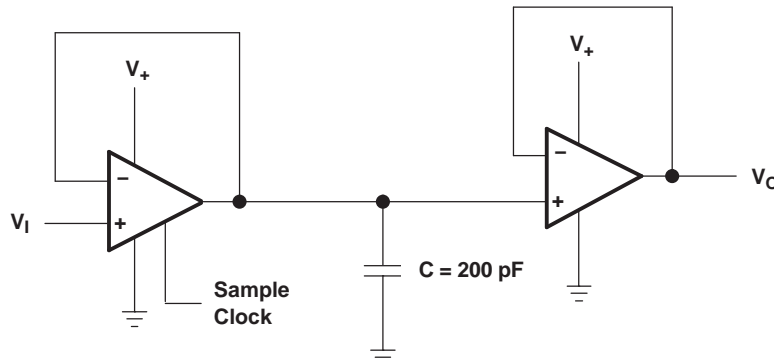
(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

(3) DBV/DCK: The actual top-side marking has one additional character that designates the wafer fab/assembly site.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

APPLICATION CIRCUIT: SAMPLE-AND-HOLD CIRCUIT



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

V ₊	Supply voltage ⁽²⁾		5.5 V
V _{ID}	Differential input voltage ⁽³⁾		±5.5 V
V _I	Input voltage range (either input)		0 to 5.5 V
θ _{JA}	Package thermal impedance ⁽⁴⁾⁽⁵⁾	DBV package	165°C/W
		DCK package	259°C/W
		PW package	113°C/W
T _J	Operating virtual junction temperature		150°C
T _{stg}	Storage temperature range		–65°C to 150°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values (except differential voltages and V₊ specified for the measurement of I_{OS}) are with respect to the network GND.
- (3) Differential voltages are at IN+ with respect to IN–.
- (4) Maximum power dissipation is a function of T_{J(max)}, θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is P_D = (T_{J(max)} – T_A)/θ_{JA}. Operating at the absolute maximum T_J of 150°C can affect reliability.
- (5) The package thermal impedance is calculated in accordance with JESD 51-7.

RECOMMENDED OPERATING CONDITIONS

		MIN	MAX	UNIT
V ₊	Supply voltage (single-supply operation)	2.5	5.5	V
T _A	Operating free-air temperature	–40	125	°C

ESD PROTECTION

TEST CONDITIONS	TYP	UNIT
Human-Body Model (HBM)	2000	V
Machine Model (MM)	200	V

ELECTRICAL CHARACTERISTICS

 $V_+ = 2.7\text{ V}$, $\text{GND} = 0\text{ V}$, $V_{\text{IC}} = V_{\text{O}} = V_+/2$, $R_{\text{L}} > 1\text{ M}\Omega$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_{A}	LMV341			LMV344			UNIT	
			MIN	TYP ⁽¹⁾	MAX	MIN	TYP ⁽¹⁾	MAX		
V_{IO} Input offset voltage		25°C	0.25		4	0.25		4	mV	
		Full range			4.5			4.5		
α_{VIO} Average temperature coefficient of input offset voltage		Full range	1.7			1.7			$\mu\text{V}/^\circ\text{C}$	
I_{IB} Input bias current		25°C	1		120	1		120	pA	
		–40°C to 85°C			250			250		
		–40°C to 125°C			3			3	nA	
I_{IO} Input offset current		25°C	6.6			6.6			fA	
CMRR Common-mode rejection ratio	$0 \leq V_{\text{ICR}} \leq 1.7\text{ V}$	25°C	40		80	56		80	dB	
	$0 \leq V_{\text{ICR}} \leq 1.6\text{ V}$	Full range	36			50				
k_{SVR} Supply-voltage rejection ratio	$2.7\text{ V} \leq V_+ \leq 5\text{ V}$	25°C	45		82	65		82	dB	
		Full range	60			60				
V_{ICR} Common-mode input voltage range	CMRR $\geq 50\text{ dB}$	25°C	0	–0.2 to 1.9	1.7	0	–0.2 to 1.9	1.7	V	
A_{V} Large-signal voltage gain ⁽²⁾	$R_{\text{L}} = 10\text{ k}\Omega$ to 1.35 V	25°C	73		113	78		113	dB	
		Full range	66			70				
	$R_{\text{L}} = 2\text{ k}\Omega$ to 1.35 V	25°C	70		103	72		103		
		Full range	63			64				
V_{O} Output swing (delta from supply rails)	$R_{\text{L}} = 2\text{ k}\Omega$ to 1.35 V	Low level	25°C	24		60	24		60	mV
			Full range	95			95			
		High level	25°C	26		60	26		60	
			Full range	95			95			
	$R_{\text{L}} = 10\text{ k}\Omega$ to 1.35 V	Low level	25°C	5		30	5		30	
			Full range	40			40			
		High level	25°C	5.3		30	5.3		30	
			Full range	40			40			
I_{CC} Supply current (per channel)		25°C	100		170	100		170	μA	
		Full range	230			230				
I_{OS} Output short-circuit current	Sourcing	25°C	20		32	18		24	mA	
	Sinking		15		24	15		24		
SR Slew rate	$R_{\text{L}} = 10\text{ k}\Omega$ ⁽³⁾	25°C	1			1			V/ μs	
GBM Unity-gain bandwidth	$R_{\text{L}} = 10\text{ k}\Omega$, $C_{\text{L}} = 200\text{ pF}$	25°C	1			1			MHz	
Φ_{m} Phase margin	$R_{\text{L}} = 100\text{ k}\Omega$	25°C	72			72			deg	
G_{m} Gain margin	$R_{\text{L}} = 100\text{ k}\Omega$	25°C	20			20			dB	
V_{n} Equivalent input noise voltage	$f = 1\text{ kHz}$	25°C	40			40			nV/ $\sqrt{\text{Hz}}$	
I_{n} Equivalent input noise current	$f = 1\text{ kHz}$	25°C	0.001			0.001			pA/ $\sqrt{\text{Hz}}$	
THD Total harmonic distortion	$f = 1\text{ kHz}$, $A_{\text{V}} = 1$, $R_{\text{L}} = 600\ \Omega$, $V_{\text{I}} = 1\text{ V}_{\text{PP}}$	25°C	0.017			0.017			%	

(1) Typical values represent the most likely parametric norm.

(2) $\text{GND} + 0.2\text{ V} \leq V_{\text{O}} \leq V_+ - 0.2\text{ V}$

(3) Connected as voltage follower with 2- V_{PP} step input. Number specified is the slower of the positive and negative slew rates.

SHUTDOWN CHARACTERISTICS

$V_+ = 2.7\text{ V}$, $GND = 0\text{ V}$, $V_{IC} = V_O = V_+/2$, $R_L > 1\text{ M}\Omega$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A	MIN	TYP	MAX	UNIT
$I_{CC(SHDN)}$	Supply current in shutdown mode (per channel)	$V_{SD} = 0\text{ V}$	25°C		0.045	1000	nA
			Full range			1.5	μA
$t_{(on)}$	Amplifier turn-on time		25°C		5		μs
V_{SD}	Shutdown pin voltage range	ON mode	25°C	1.7 to 2.7	2.4 to 2.7		V
		Shutdown mode		0 to 1	0 to 0.8		

ELECTRICAL CHARACTERISTICS

 $V_+ = 5\text{ V}$, $\text{GND} = 0\text{ V}$, $V_{IC} = V_O = V_+/2$, $R_L > 1\text{ M}\Omega$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS	T _A	LMV341			LMV344			UNIT	
			MIN	TYP ⁽¹⁾	MAX	MIN	TYP ⁽¹⁾	MAX		
V _{IO}	Input offset voltage	25°C	0.25		4	0.25		4	mV	
		Full range			4.5			4.5		
α_{VIO}	Average temperature coefficient of input offset voltage	Full range	1.9			1.9			$\mu\text{V}/^\circ\text{C}$	
I _{IB}	Input bias current	25°C	1		200	1		200	pA	
		–40°C to 85°C			375			375		
		–40°C to 125°C			5			5	nA	
I _{IO}	Input offset current	25°C	6.6			6.6			fA	
CMRR	Common-mode rejection ratio	$0 \leq V_{ICR} \leq 4\text{ V}$	46	86		56	86		dB	
		$0 \leq V_{ICR} \leq 3.9\text{ V}$	Full range			50				
k _{SVR}	Supply-voltage rejection ratio	25°C	45	82		65	82		dB	
		Full range	44			60				
V _{ICR}	Common-mode input voltage range	CMRR $\geq 50\text{ dB}$	25°C	0	–0.2 to 4.2	4	0	–0.2 to 4.2	4	V
A _V	Large-signal voltage gain ⁽²⁾	R _L = 10 k Ω to 2.5 V	25°C	78	116		78	116		dB
			Full range	70			70			
		R _L = 2 k Ω to 2.5 V	25°C	72	107		72	107		
			Full range	64			64			
V _O	Output swing (delta from supply rails)	R _L = 2 k Ω to 2.5 V	Low level	25°C	32	67		32	60	mV
				Full range	95			95		
			High level	25°C	34	60		34	60	
				Full range	95			95		
		R _L = 10 k Ω to 2.5 V	Low level	25°C	7	30		7	30	
				Full range	45			40		
			High level	25°C	7	30		7	30	
				Full range	40			40		
I _{CC}	Supply current (per channel)	25°C	107	200		107	200	μA		
		Full range	260			260				
I _{OS}	Output short-circuit current	Sourcing	25°C	85	113		70	90	mA	
		Sinking	50 75			50 75				
SR	Slew rate	R _L = 10 k Ω ⁽³⁾	25°C	1			1			V/ μs
GBM	Unity-gain bandwidth	R _L = 10 k Ω , C _L = 200 pF	25°C	1			1			MHz
Φ_m	Phase margin	R _L = 100 k Ω	25°C	70			70			deg
G _m	Gain margin	R _L = 100 k Ω	25°C	20			20			dB
V _n	Equivalent input noise voltage	f = 1 kHz	25°C	39			39			nV/ $\sqrt{\text{Hz}}$
I _n	Equivalent input noise current	f = 1 kHz	25°C	0.001			0.001			pA/ $\sqrt{\text{Hz}}$
THD	Total harmonic distortion	f = 1 kHz, A _V = 1, R _L = 600 Ω , V _I = 1 V _{PP}	25°C	0.012			0.012			%

(1) Typical values represent the most likely parametric norm.

(2) $\text{GND} + 0.2\text{ V} \leq V_O \leq V_+ - 0.2\text{ V}$

(3) Connected as voltage follower with 2-V_{PP} step input. Number specified is the slower of the positive and negative slew rates.

SHUTDOWN CHARACTERISTICS

$V_+ = 5\text{ V}$, $\text{GND} = 0\text{ V}$, $V_{IC} = V_O = V_+/2$, $R_L > 1\text{ M}\Omega$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	T_A	MIN	TYP	MAX	UNIT
$I_{CC(\text{SHDN})}$	Supply current in shutdown mode (per channel)	$V_{SD} = 0\text{ V}$	25°C		0.033	1	μA
			Full range			1.5	
$t_{(\text{on})}$	Amplifier turn-on time		25°C		5		μs
V_{SD}	Shutdown pin voltage range	ON mode	25°C		3.1 to 5	4.5 to 5	V
		Shutdown mode			0 to 1	0 to 0.8	

TYPICAL CHARACTERISTICS

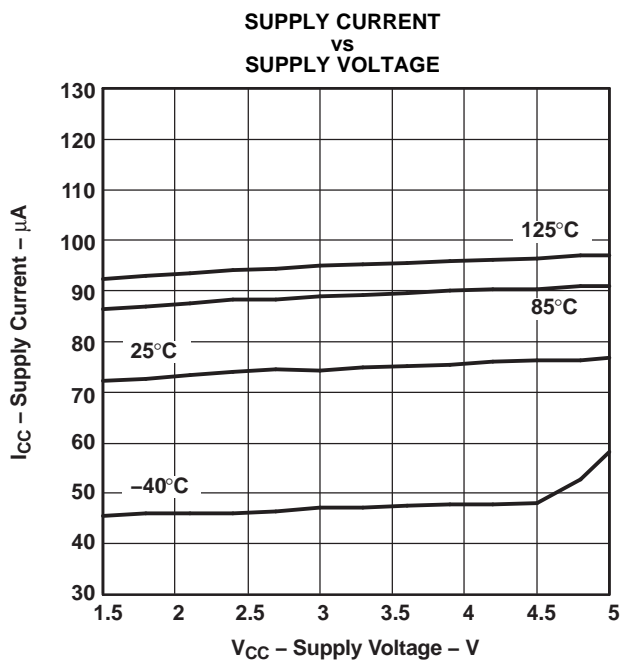


Figure 1.

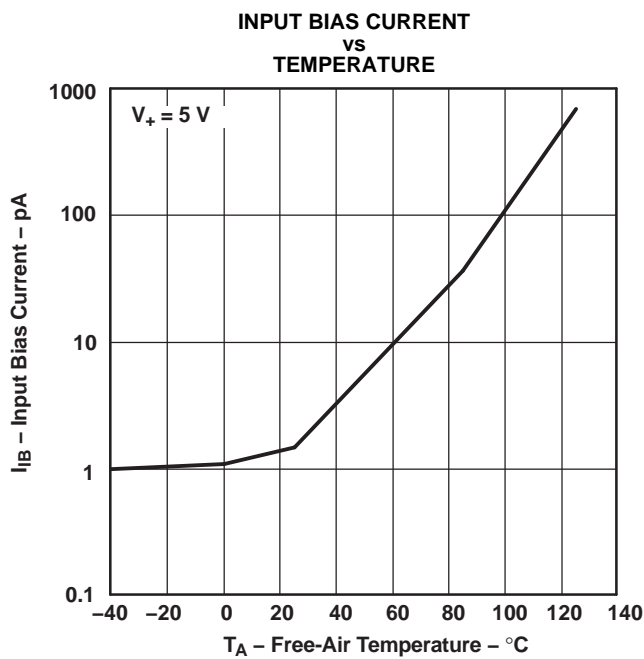


Figure 2.

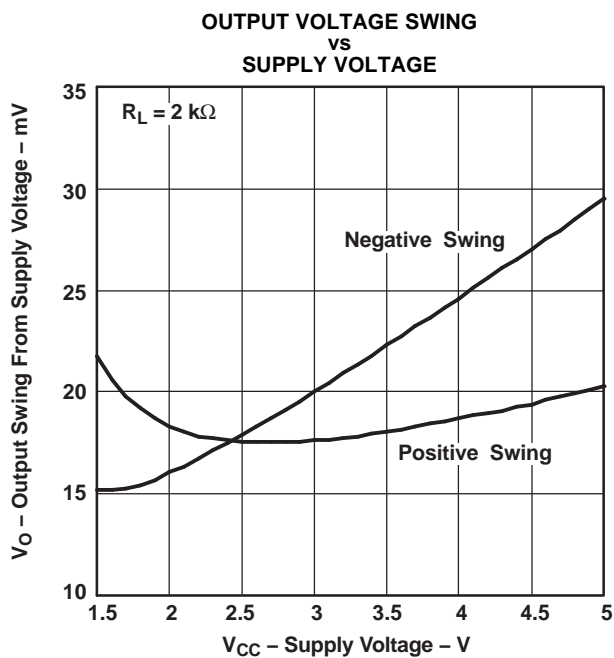


Figure 3.

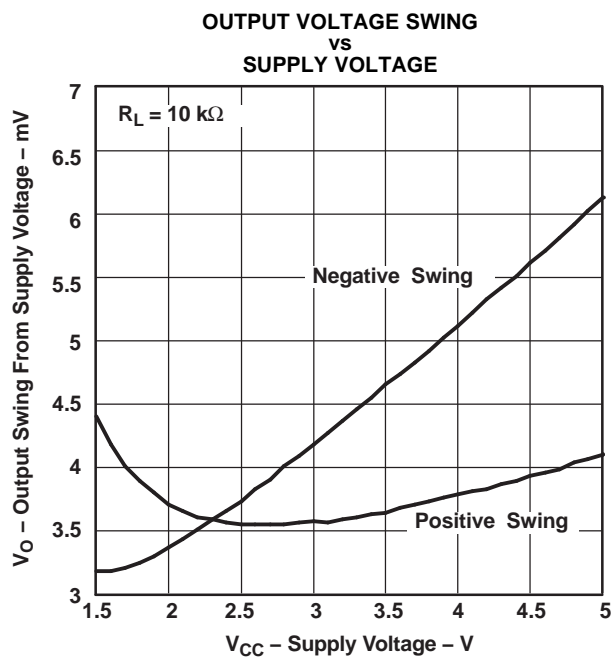
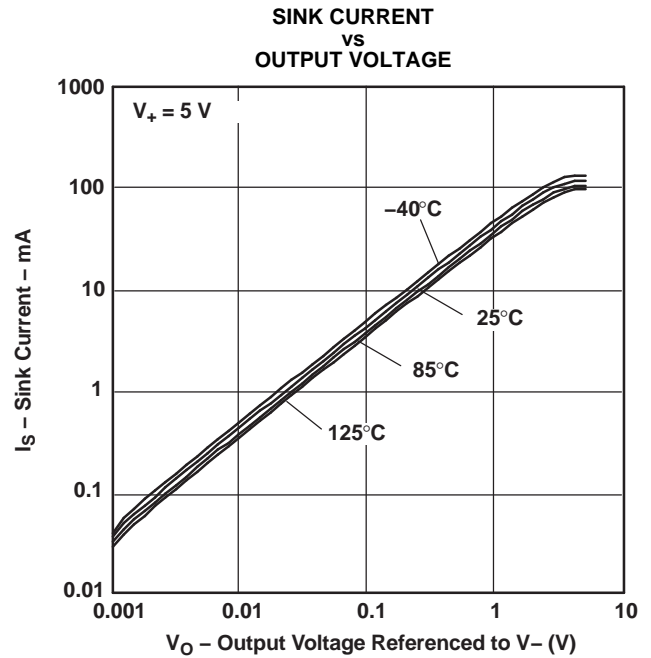
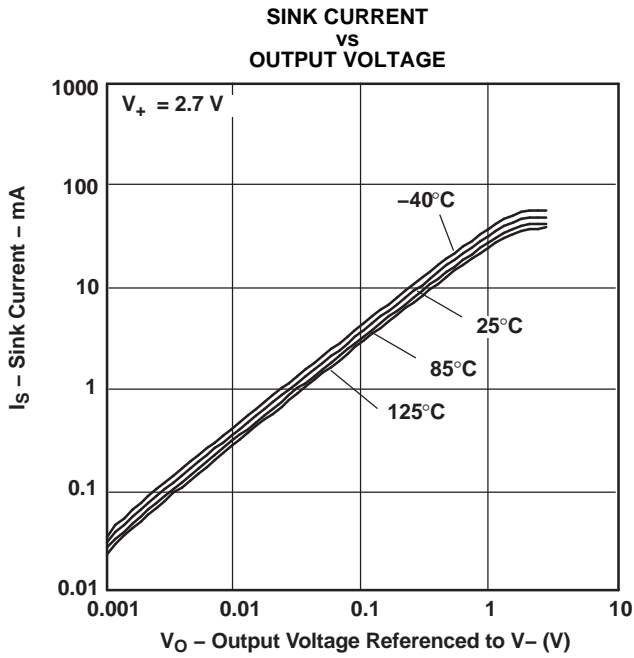
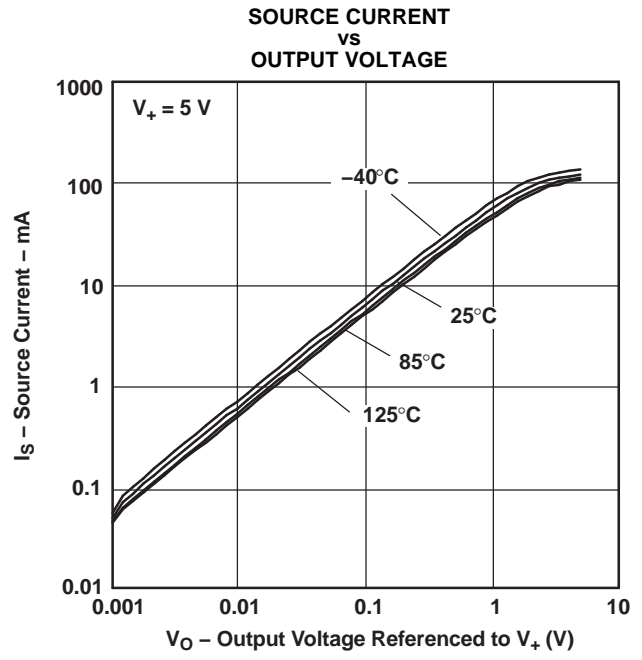
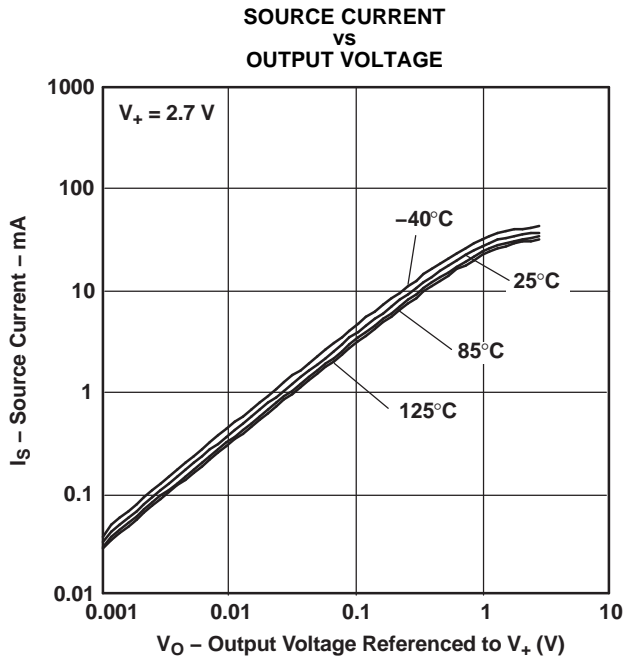


Figure 4.

TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

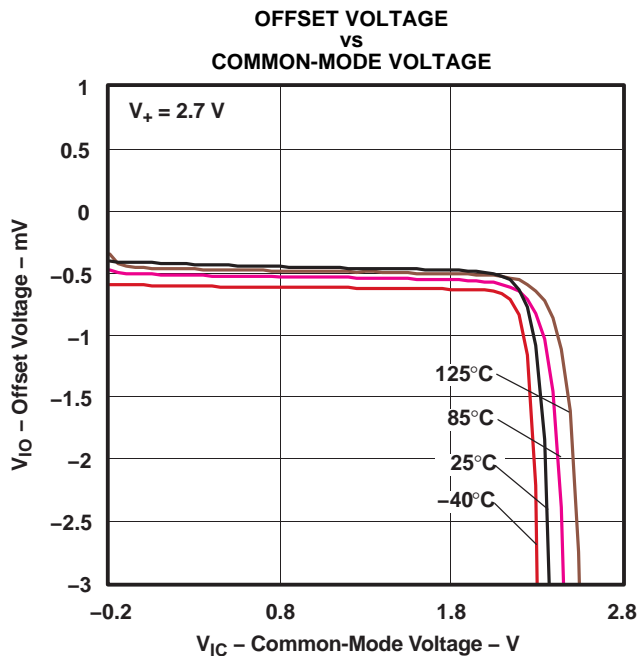


Figure 9.

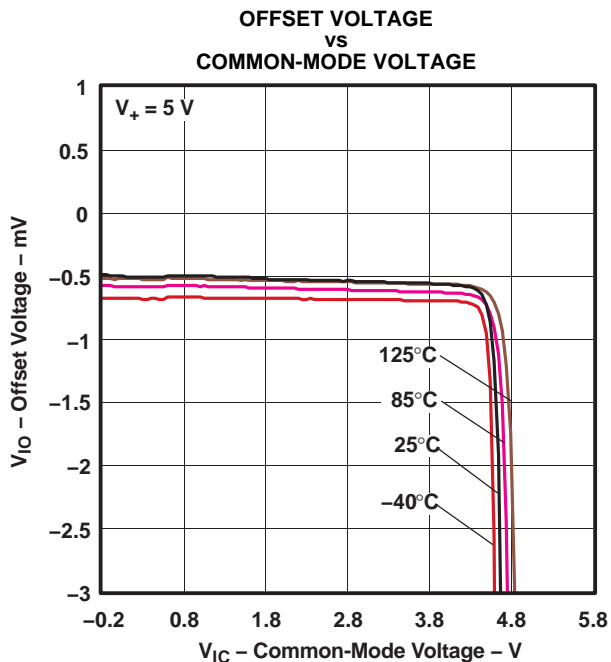


Figure 10.

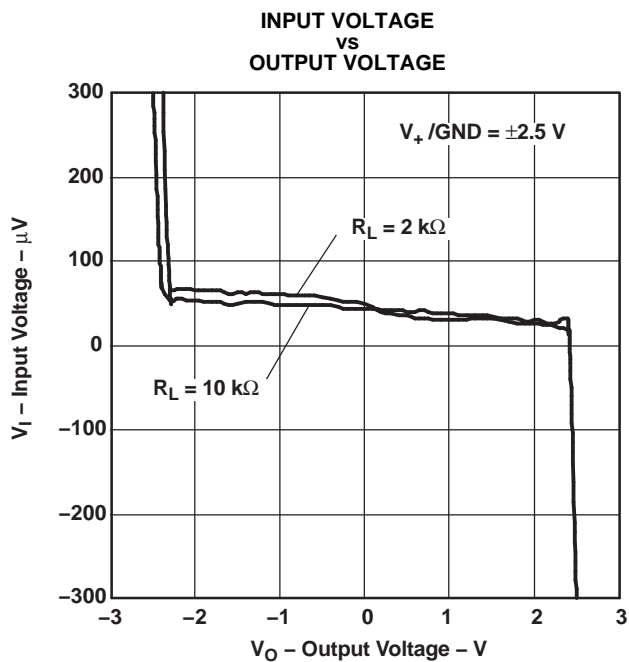


Figure 11.

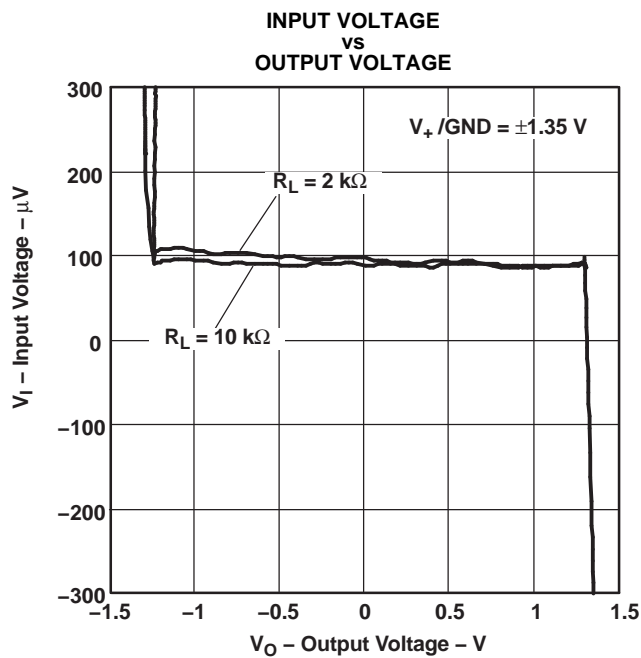


Figure 12.

TYPICAL CHARACTERISTICS (continued)

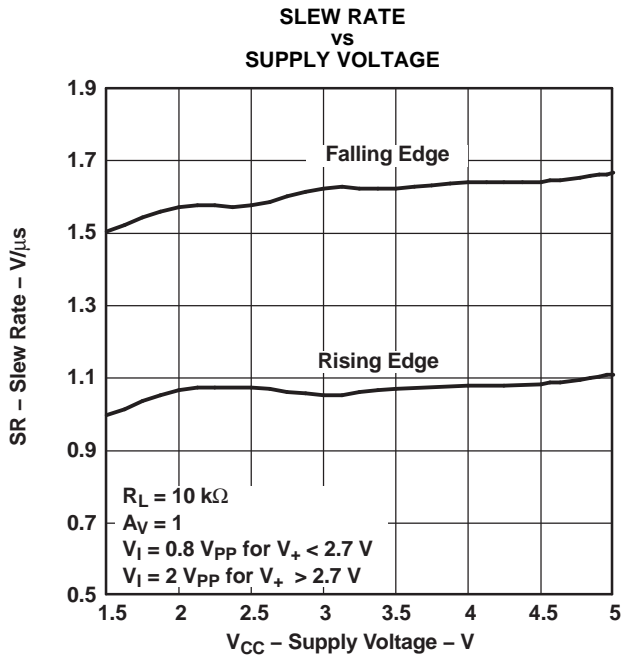


Figure 13.

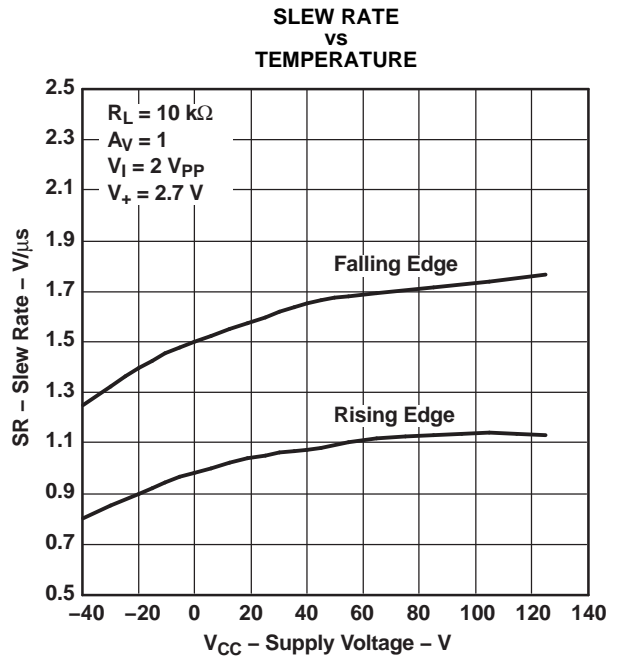


Figure 14.

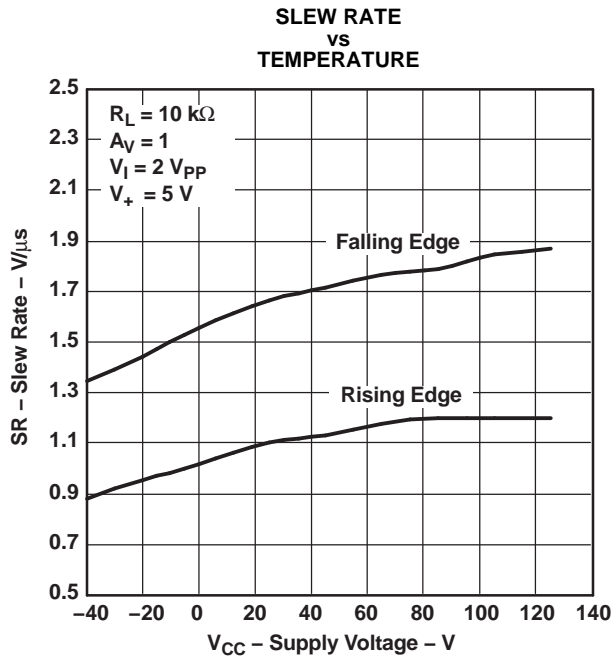


Figure 15.

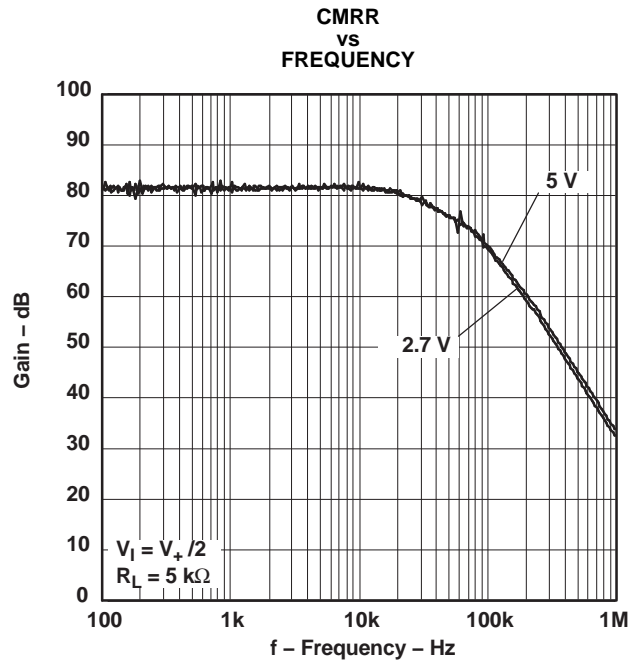


Figure 16.

TYPICAL CHARACTERISTICS (continued)

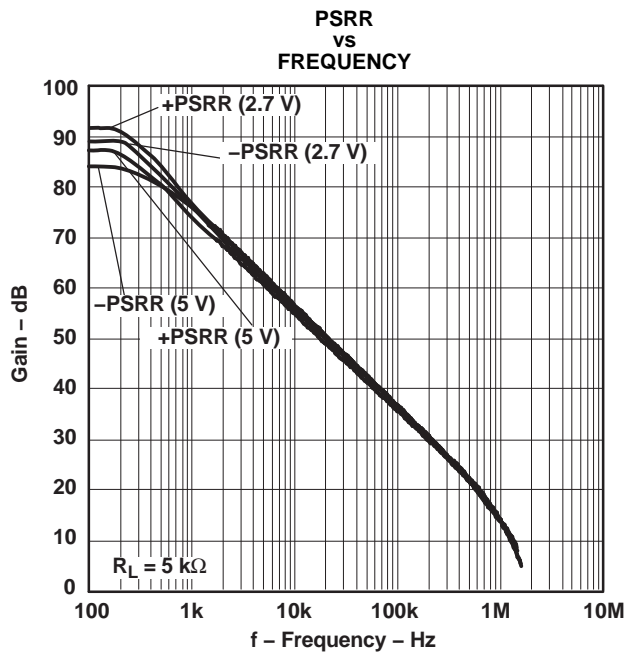


Figure 17.

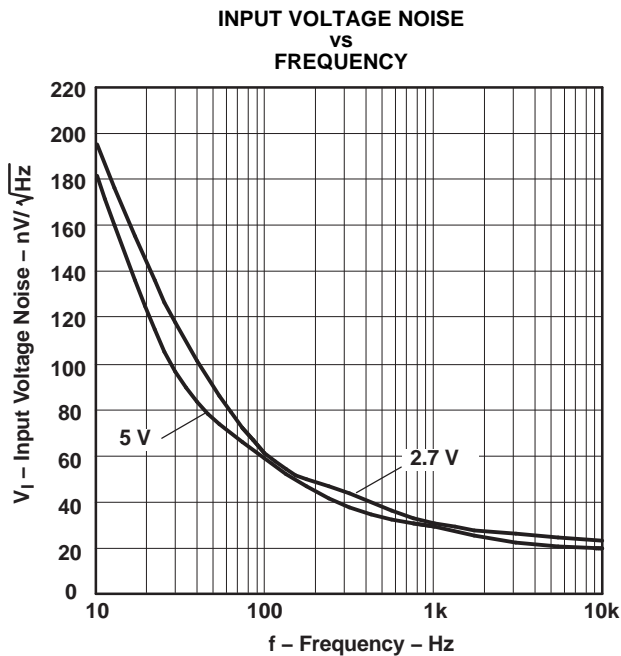


Figure 18.

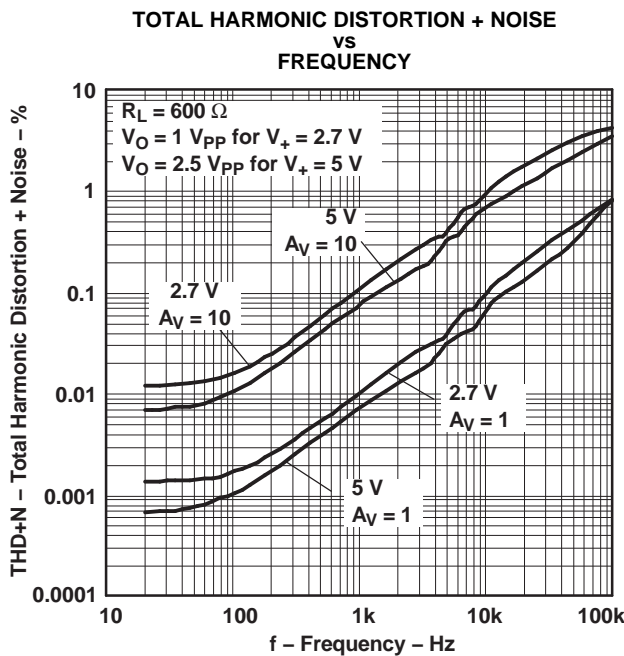


Figure 19.

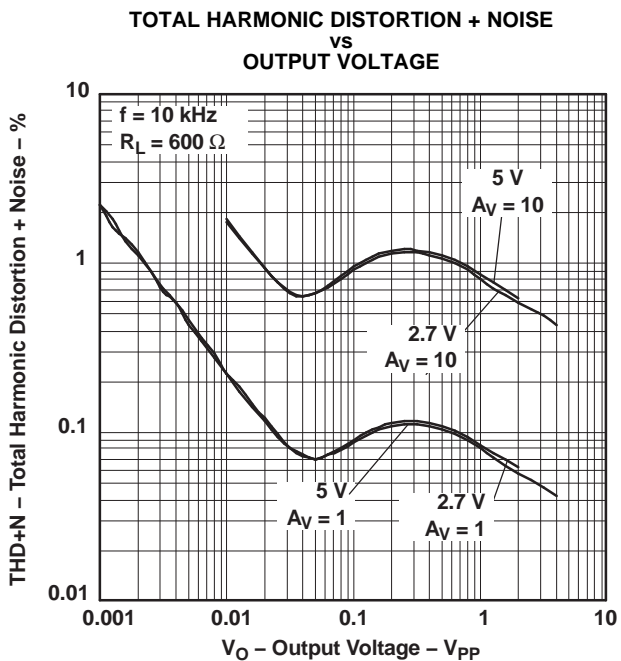


Figure 20.

TYPICAL CHARACTERISTICS (continued)

GAIN AND PHASE MARGIN
vs
FREQUENCY
($T_A = -40^\circ\text{C}, 25^\circ\text{C}, 125^\circ\text{C}$)

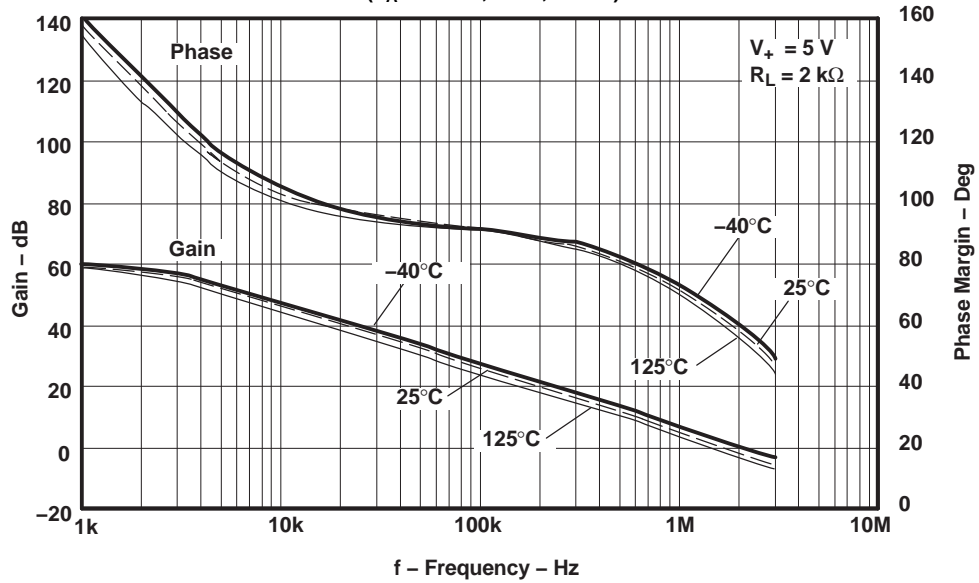


Figure 21.

GAIN AND PHASE MARGIN
vs
FREQUENCY
($R_L = 600\ \Omega, 2\text{ k}\Omega, 100\text{ k}\Omega$)

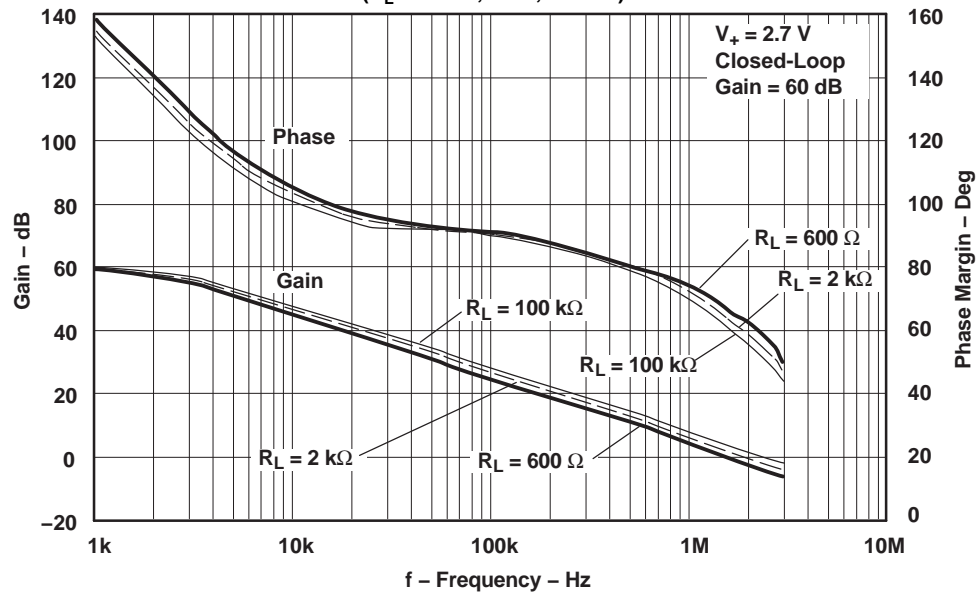


Figure 22.

TYPICAL CHARACTERISTICS (continued)

GAIN AND PHASE MARGIN
vs
FREQUENCY
($R_L = 600 \Omega, 2 \text{ k}\Omega, 100 \text{ k}\Omega$)

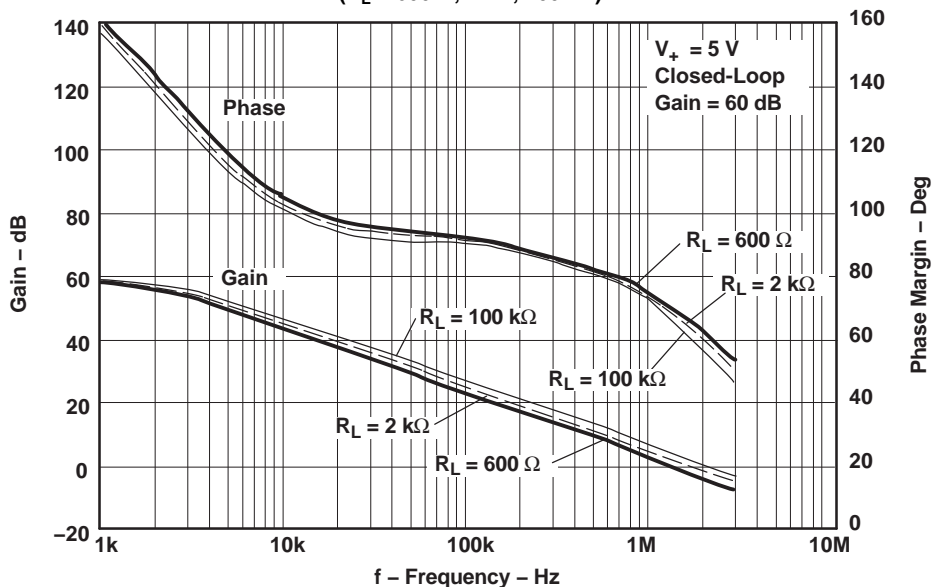


Figure 23.

GAIN AND PHASE MARGIN
vs
FREQUENCY
($C_L = 0 \text{ pF}, 100 \text{ pF}, 500 \text{ pF}, 1000 \text{ pF}$)

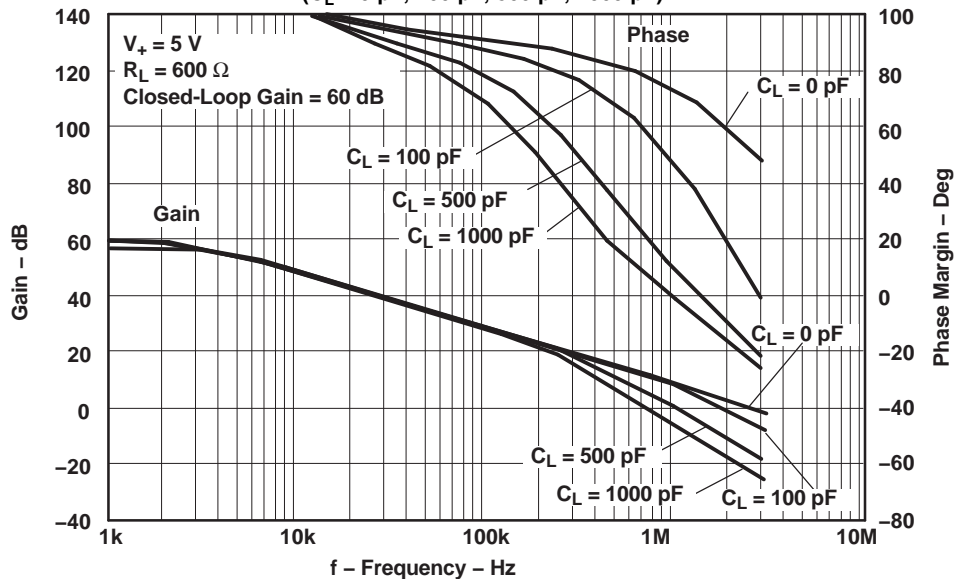


Figure 24.

TYPICAL CHARACTERISTICS (continued)

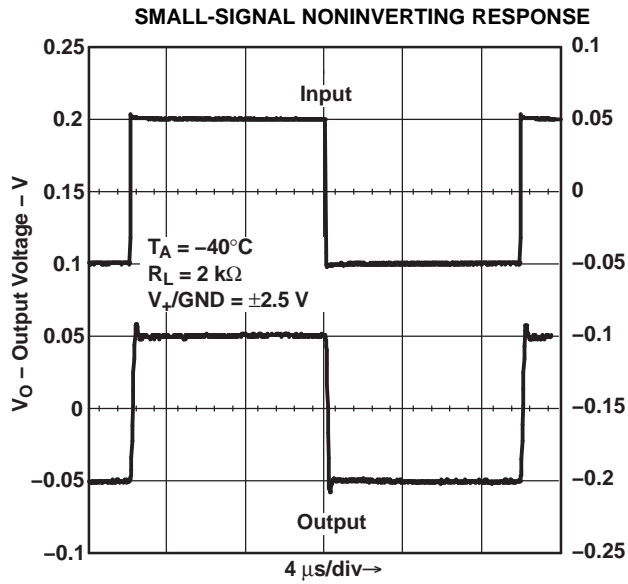


Figure 25.

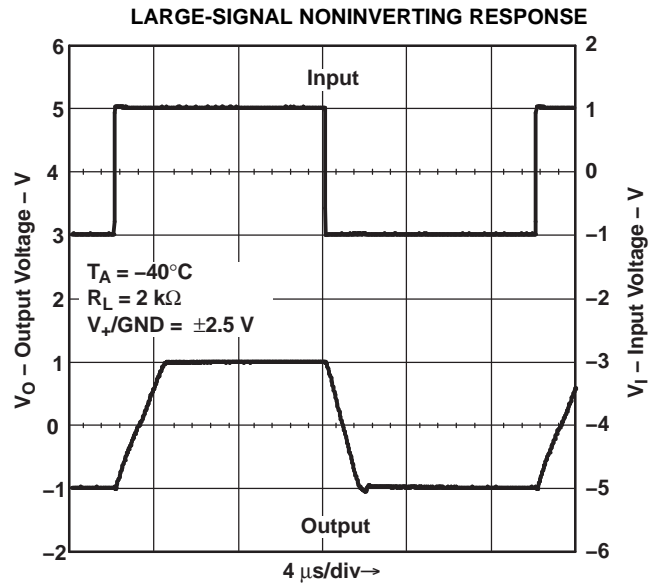


Figure 26.

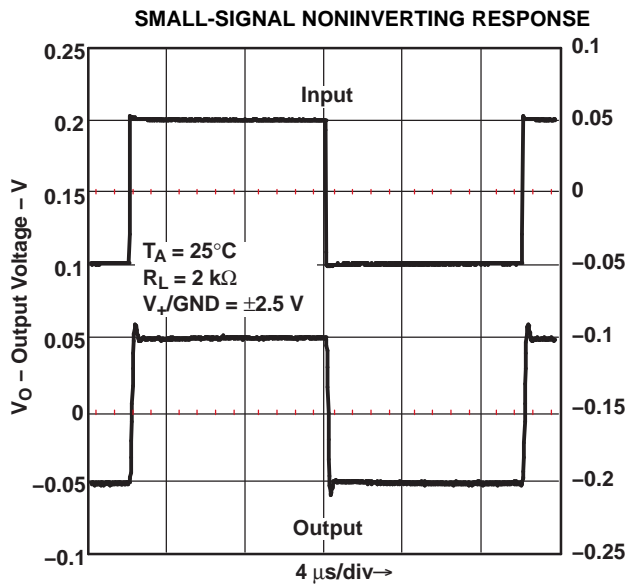


Figure 27.

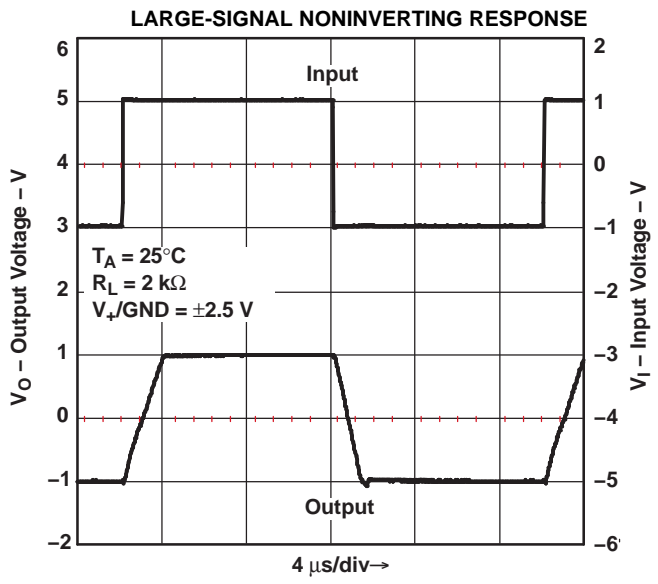


Figure 28.

TYPICAL CHARACTERISTICS (continued)

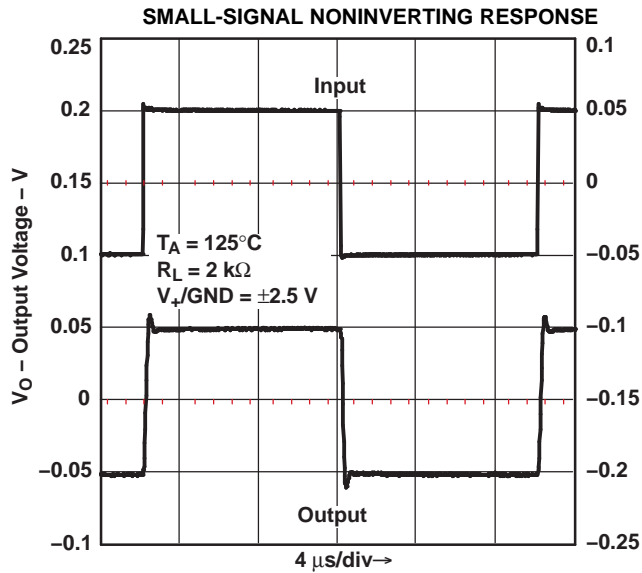


Figure 29.

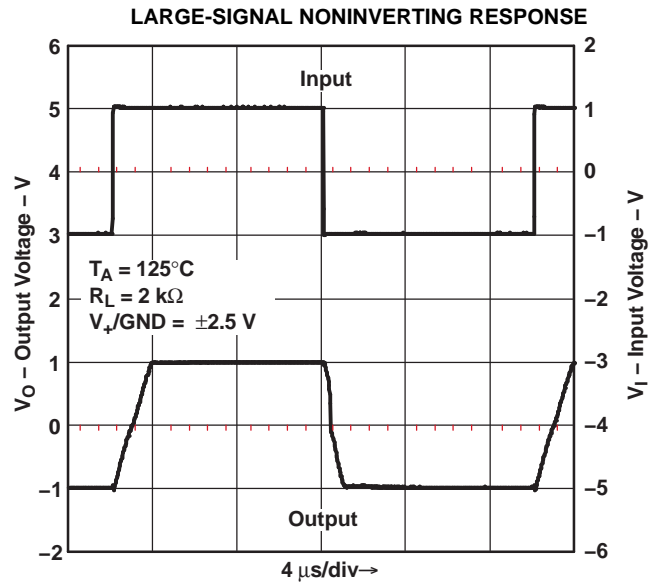


Figure 30.

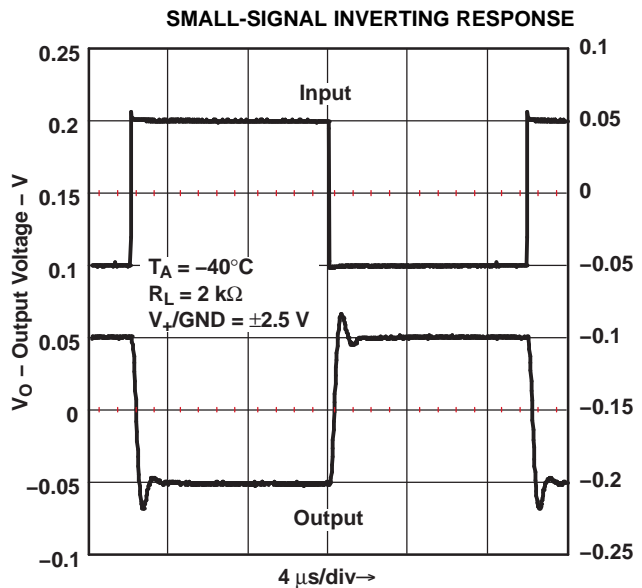


Figure 31.

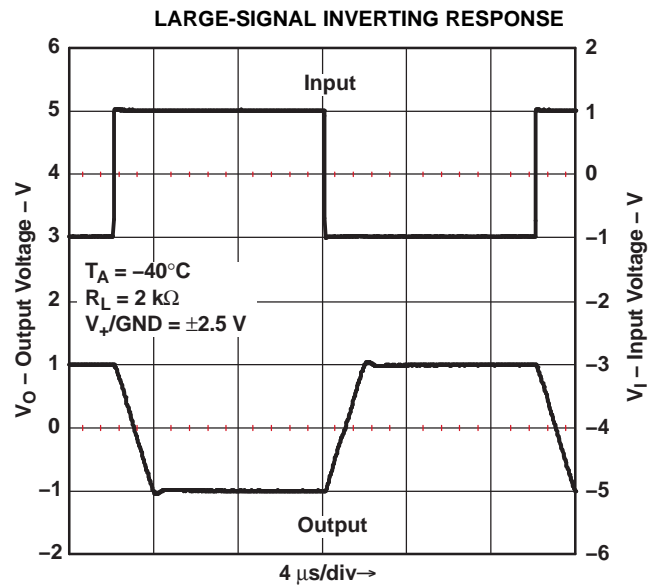


Figure 32.

TYPICAL CHARACTERISTICS (continued)

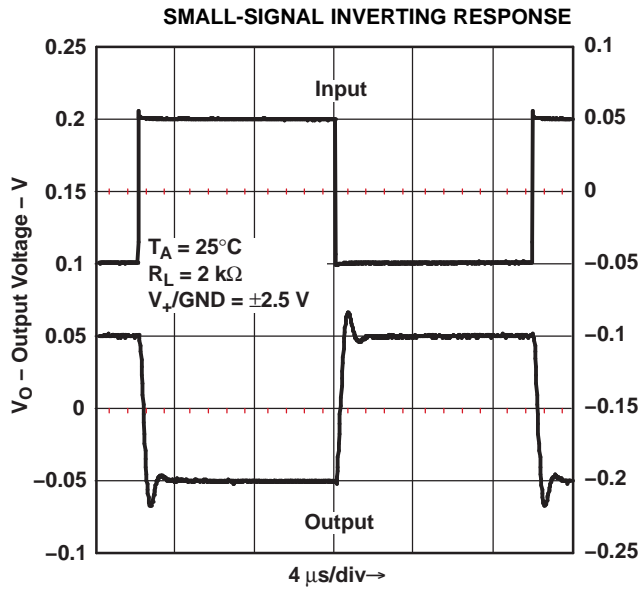


Figure 33.

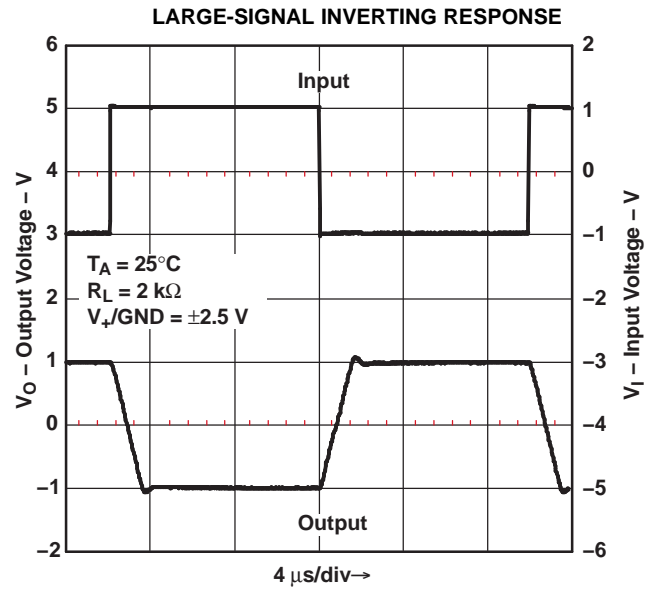


Figure 34.

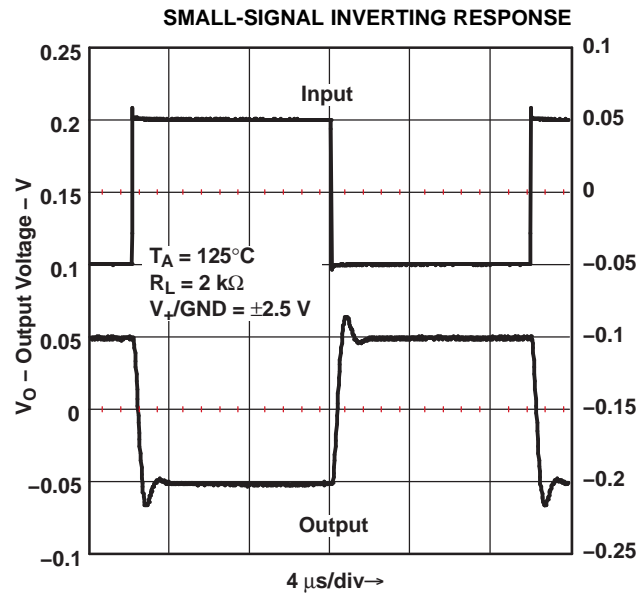


Figure 35.

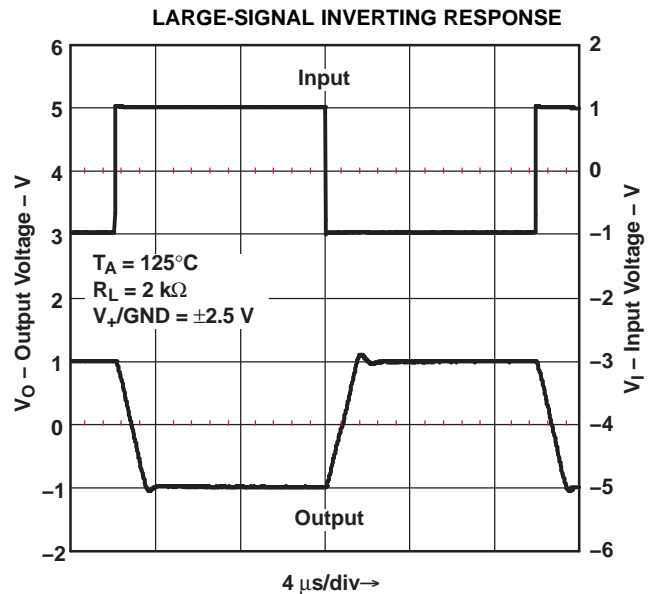


Figure 36.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LMV341QDBVRQ1	ACTIVE	SOT-23	DBV	6	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	RCHE	Samples
LMV341QDCKRQ1	ACTIVE	SC70	DCK	6	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	RRE	Samples
LMV344IPWRQ1	ACTIVE	TSSOP	PW	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 125	LMV344Q	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF LMV341-Q1, LMV344-Q1 :

- Catalog: [LMV341](#), [LMV344](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMV341QDBVRQ1	SOT-23	DBV	6	3000	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMV341QDCKRQ1	SC70	DCK	6	3000	179.0	8.4	2.2	2.5	1.2	4.0	8.0	Q3
LMV344IPWRQ1	TSSOP	PW	14	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

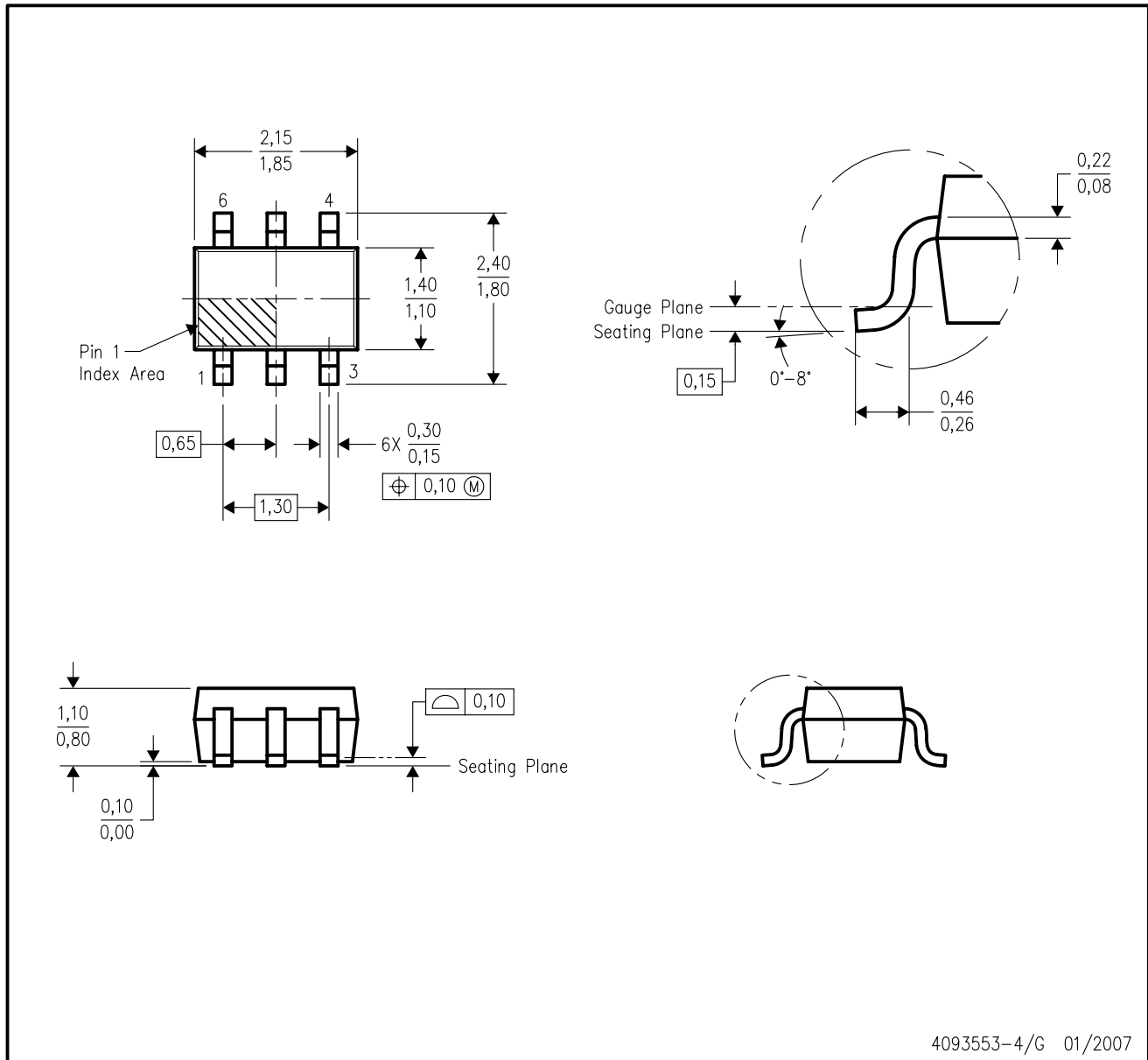
TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMV341QDBVRQ1	SOT-23	DBV	6	3000	200.0	183.0	25.0
LMV341QDCKRQ1	SC70	DCK	6	3000	200.0	183.0	25.0
LMV344IPWRQ1	TSSOP	PW	14	2000	367.0	367.0	35.0

DCK (R-PDSO-G6)

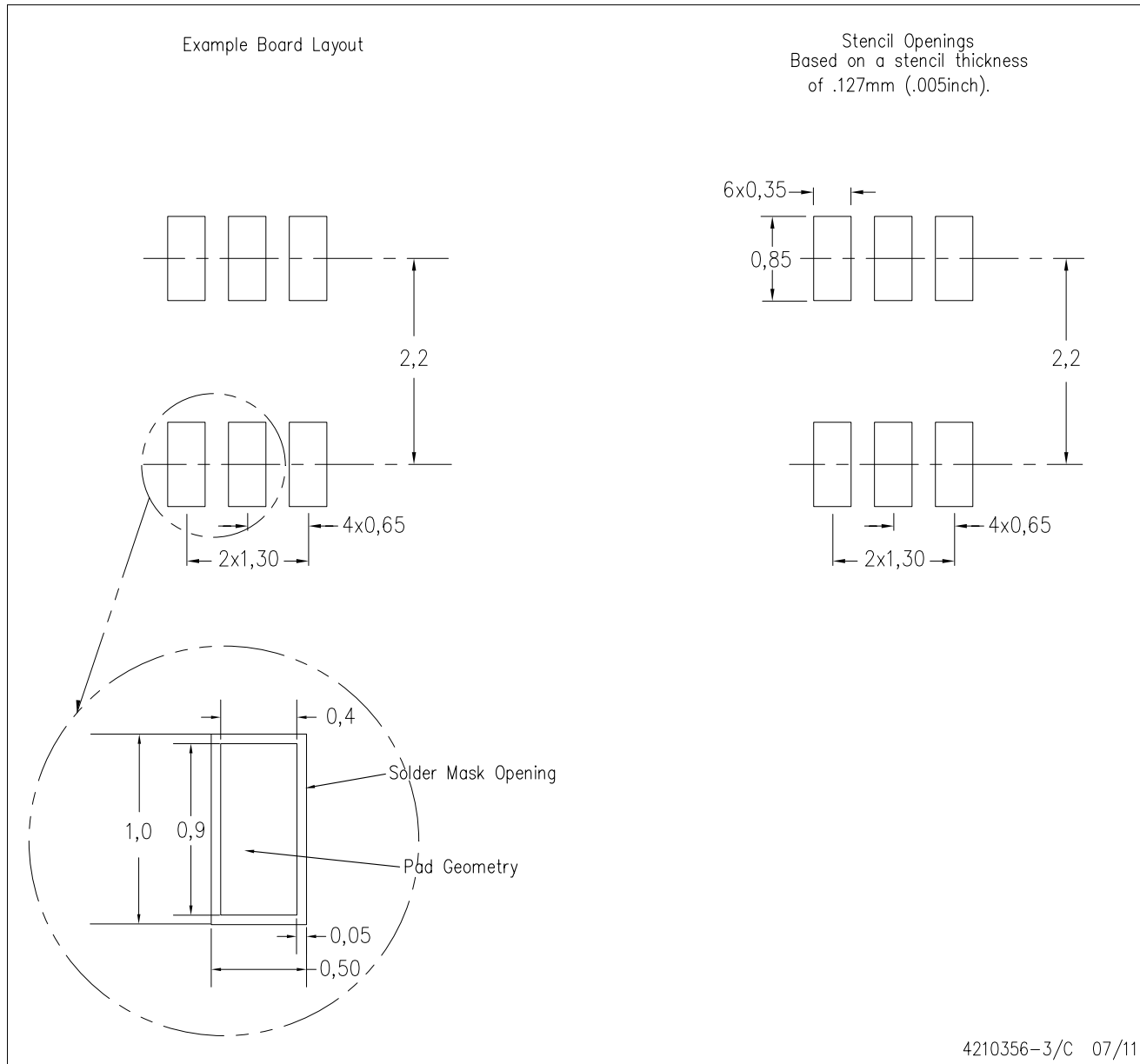
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-203 variation AB.

DCK (R-PDSO-G6)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
 - Publication IPC-7351 is recommended for alternate designs.
 - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
 - E. Falls within JEDEC MO-153

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Publication IPC-7351 is recommended for alternate designs.
 - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

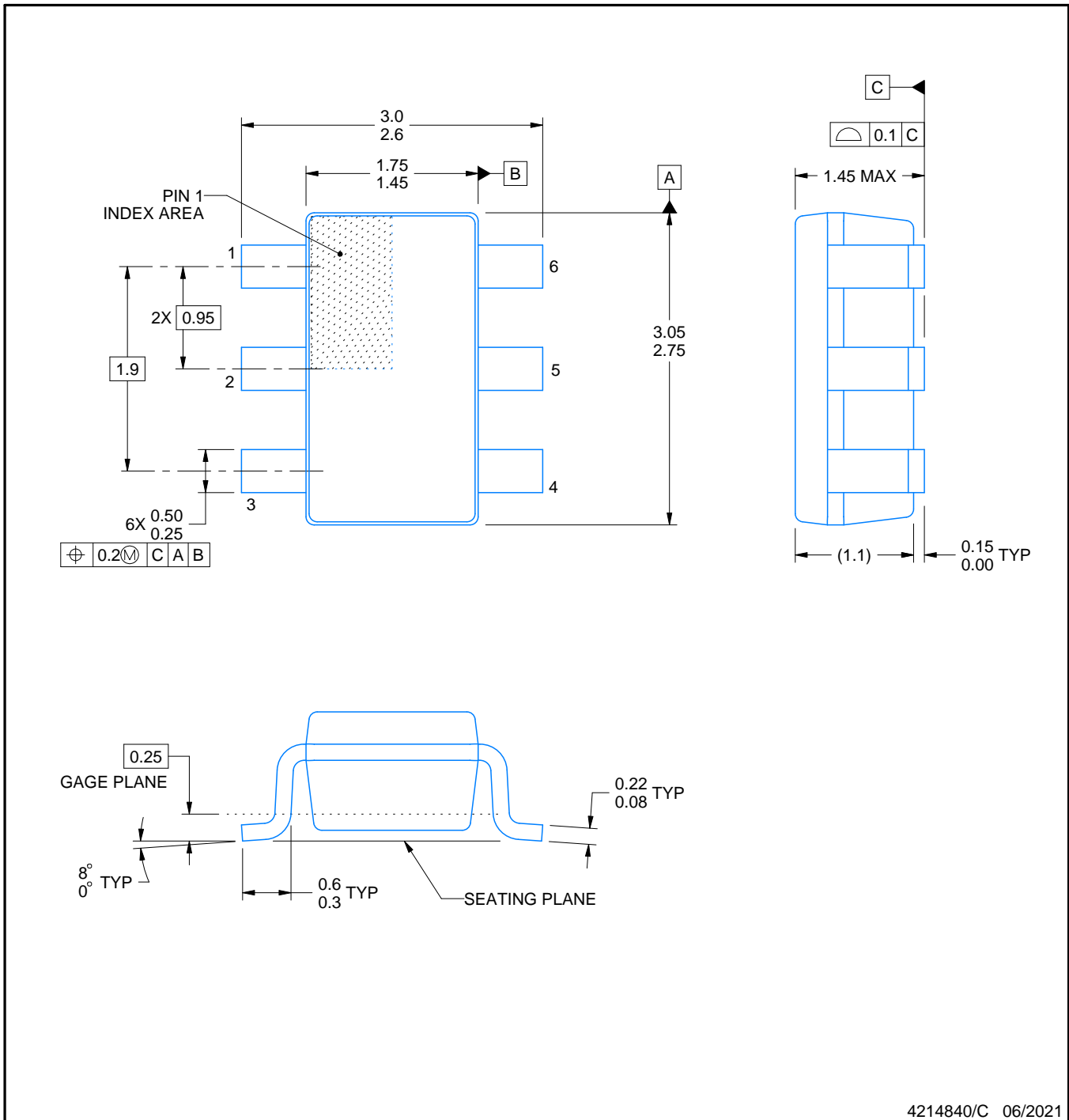
DBV0006A



PACKAGE OUTLINE

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



4214840/C 06/2021

NOTES:

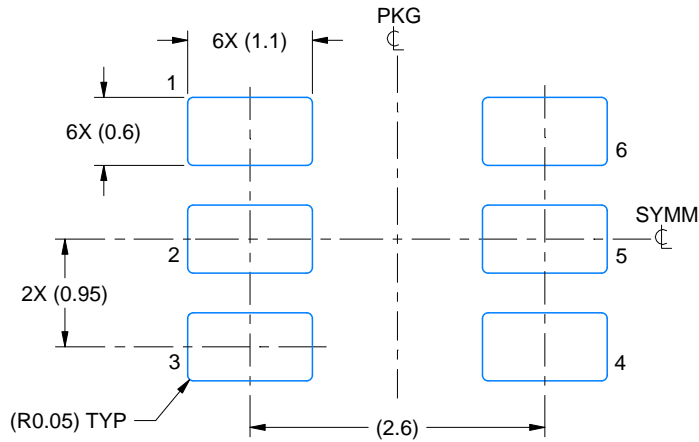
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.25 per side.
4. Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
5. Reference JEDEC MO-178.

EXAMPLE BOARD LAYOUT

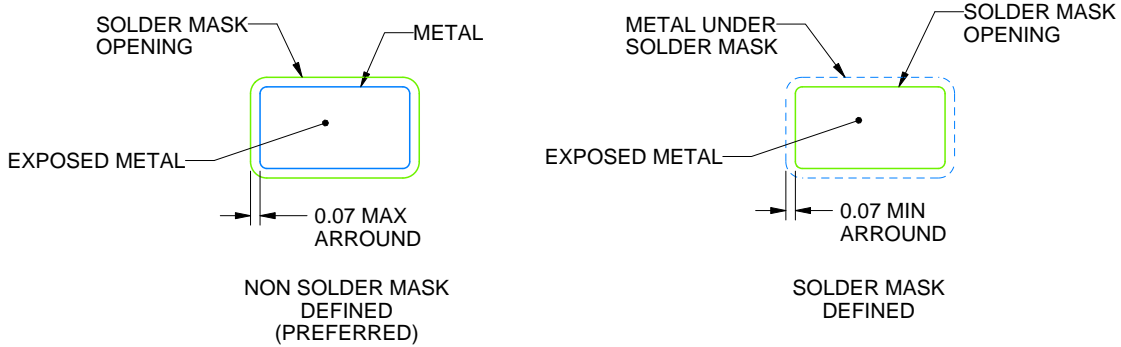
DBV0006A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:15X



SOLDER MASK DETAILS

4214840/C 06/2021

NOTES: (continued)

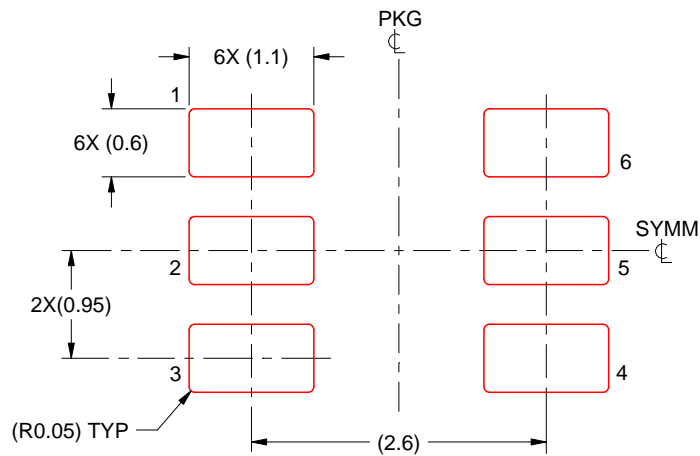
- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DBV0006A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:15X

4214840/C 06/2021

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2022, Texas Instruments Incorporated

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [Operational Amplifiers - Op Amps category](#):

Click to view products by [Texas Instruments manufacturer](#):

Other Similar products are found below :

[430227FB](#) [LT1678IS8](#) [NCV33202DMR2G](#) [NJM324E](#) [M38510/13101BPA](#) [NTE925](#) [AZV358MTR-G1](#) [AP4310AUMTR-AG1](#)
[AZV358MMTR-G1](#) [SCY33178DR2G](#) [NCV20034DR2G](#) [NTE778S](#) [NTE871](#) [NTE937](#) [NJU7057RB1-TE2](#) [SCY6358ADR2G](#)
[NJM2904CRB1-TE1](#) [UPC4570G2-E1-A](#) [UPC4741G2-E1-A](#) [NJM8532RB1-TE1](#) [EL2250CS](#) [EL5100IS](#) [EL5104IS](#) [EL5127CY](#) [EL5127CZY](#)
[EL5133IW](#) [EL5152IS](#) [EL5156IS](#) [EL5162IS](#) [EL5202IY](#) [EL5203IY](#) [EL5204IY](#) [EL5210CS](#) [EL5210CZY](#) [EL5211IYE](#) [EL5220CY](#)
[EL5223CLZ](#) [EL5223CR](#) [EL5224ILZ](#) [EL5227CLZ](#) [EL5227CRZ](#) [EL5244CS](#) [EL5246CS](#) [EL5246CSZ](#) [EL5250IY](#) [EL5251IS](#) [EL5257IS](#)
[EL5260IY](#) [EL5261IS](#) [EL5300IU](#)